



## General Description

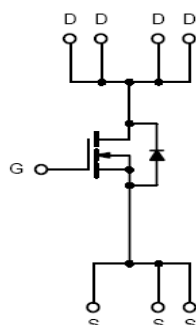
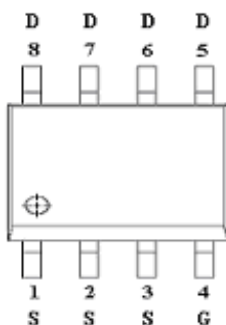
AFN4440W, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge.

These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

## Features

- $I_D=6.8A, R_{DS(ON)}=40m\Omega @ V_{GS}=10V$
- $I_D=5.6A, R_{DS(ON)}=45m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- SOP-8P package design

## Pin Description ( SOP-8P )



## Application

- Motor and Load Control
- Power Management in White LED System
- Push Pull Converter
- LCD TV Inverter & AD/DC Inverter Systems.

## Pin Define

| Pin | Symbol | Description |
|-----|--------|-------------|
| 1   | S      | Source      |
| 2   | S      | Source      |
| 3   | S      | Source      |
| 4   | G      | Gate        |
| 5   | D      | Drain       |
| 6   | D      | Drain       |
| 7   | D      | Drain       |
| 8   | D      | Drain       |

## Ordering Information

| Part Ordering No. | Part Marking | Package | Unit        | Quantity |
|-------------------|--------------|---------|-------------|----------|
| AFN4440WS8RG      | 4440W        | SOP-8P  | Tape & Reel | 2500 EA  |

※ A Lot code

※ B Date code

※ AFN4440WS8RG : 13" Tape & Reel ; Pb- Free ; Halogen -Free



※ **Absolute Maximum Ratings**

(T<sub>A</sub>=25°C Unless otherwise noted)

| Parameter                                       | Symbol           | Value                | Unit |
|---|------------------|----------------------|------|
| Drain-Source Voltage                            | V <sub>DSS</sub> | 60                   | V    |
| Gate –Source Voltage                            | V <sub>GSS</sub> | ±20                  | V    |
| Continuous Drain Current(T <sub>J</sub> =150°C) | I <sub>D</sub>   | T <sub>A</sub> =25°C | 6.8  |
|   |                  | T <sub>A</sub> =70°C | 5.6  |
| Pulsed Drain Current                            | I <sub>DM</sub>  | 30                   | A    |
| Continuous Source Current(Diode Conduction)     | I <sub>S</sub>   | 1.5                  | A    |
| Power Dissipation                               | P <sub>D</sub>   | T <sub>A</sub> =25°C | 2.8  |
|   |                  | T <sub>A</sub> =70°C | 1.8  |
| Operating Junction Temperature                  | T <sub>J</sub>   | 150                  | °C   |
| Storage Temperature Range                       | T <sub>STG</sub> | -55/150              | °C   |
| Thermal Resistance-Junction to Ambient          | R <sub>θJA</sub> | 62.5                 | °C/W |

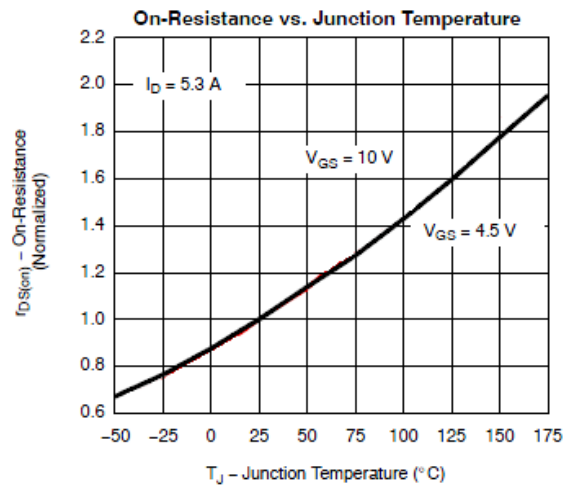
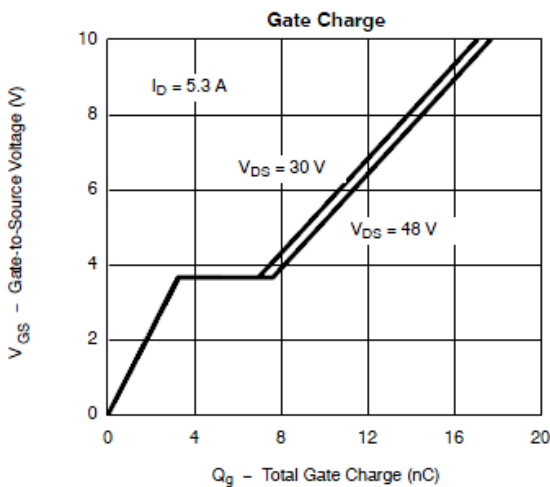
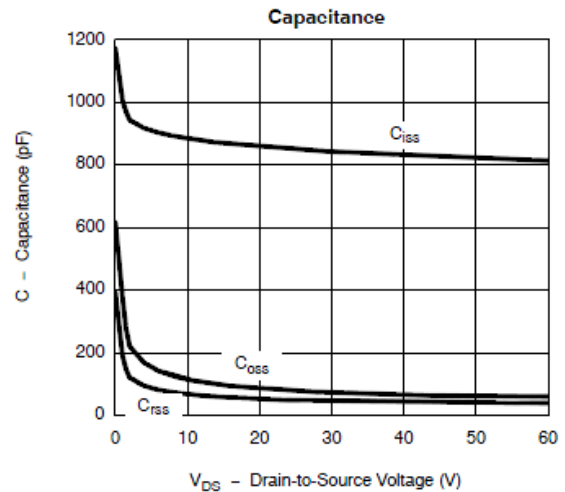
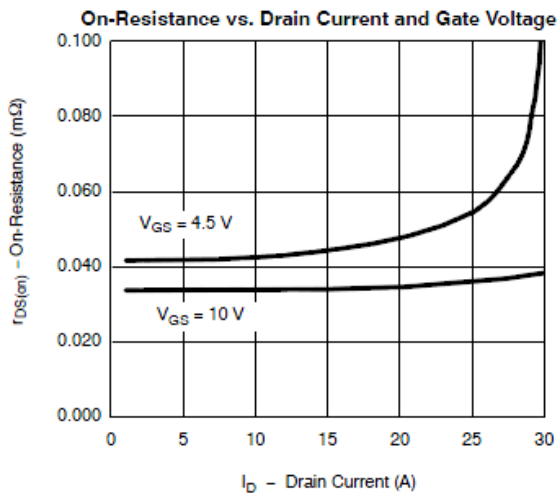
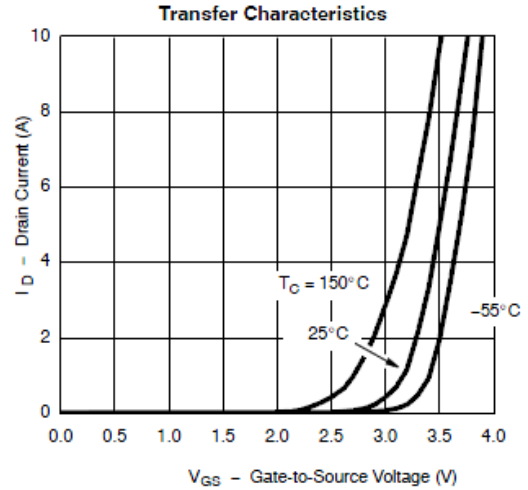
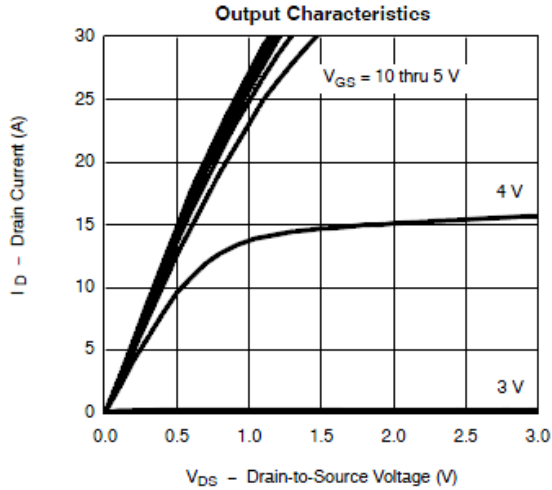
**Electrical Characteristics**

(T<sub>A</sub>=25°C Unless otherwise noted)

| Parameter                       | Symbol               | Conditions   | Min. | Typ | Max. | Unit |
|---------------------------------|----------------------|--|------|-----|------|------|
| <b>Static</b>                   |                      |  |      |     |      |      |
| Drain-Source Breakdown Voltage  | V <sub>(BR)DSS</sub> | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA   | 60   |     |      | V    |
| Gate Threshold Voltage          | V <sub>GS(th)</sub>  | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA   | 1.0  |     | 2.5  |      |
| Gate Leakage Current            | I <sub>GSS</sub>     | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V   |      |     | ±100 | nA   |
| Zero Gate Voltage Drain Current | I <sub>DSS</sub>     | V <sub>DS</sub> =60V, V <sub>GS</sub> =0V  |      |     | 1    | uA   |
|                                 |                      | V <sub>DS</sub> =60V, V <sub>GS</sub> =0V<br>T <sub>J</sub> =85°C  |      |     | 5    |      |
| On-State Drain Current          | I <sub>D(on)</sub>   | V <sub>DS</sub> ≥ 5V, V <sub>GS</sub> =4.5V  | 30   |     |      | A    |
| Drain-Source On-Resistance      | R <sub>DS(on)</sub>  | V <sub>GS</sub> =10V, I <sub>D</sub> =6.8A   |      | 38  | 40   | mΩ   |
|                                 |                      | V <sub>GS</sub> =4.5V, I <sub>D</sub> =5.6A  |      | 42  | 45   |      |
| Forward Transconductance        | g <sub>FS</sub>      | V <sub>DS</sub> =15V, I <sub>D</sub> =5.3A   |      | 24  |      | S    |
| Diode Forward Voltage           | V <sub>SD</sub>      | I <sub>S</sub> =2.0A, V <sub>GS</sub> =0V  |      | 0.8 | 1.2  | V    |
| <b>Dynamic</b>                  |                      |  |      |     |      |      |
| Total Gate Charge               | Q <sub>g</sub>       | V <sub>DS</sub> =30V, V <sub>GS</sub> =5V<br>I <sub>D</sub> ≅5.6A  |      | 10  | 15   | nC   |
| Gate-Source Charge              | Q <sub>gs</sub>      |  |      | 3.5 |      |      |
| Gate-Drain Charge               | Q <sub>gd</sub>      |  |      | 3.6 |      |      |
| Input Capacitance               | C <sub>iss</sub>     | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V<br>f=1MHz  |      | 890 |      | pF   |
| Output Capacitance              | C <sub>oss</sub>     |  |      | 85  |      |      |
| Reverse Transfer Capacitance    | C <sub>rss</sub>     |  |      | 48  |      |      |
| Turn-On Time                    | t <sub>d(on)</sub>   | V <sub>DD</sub> =30V, R <sub>L</sub> =6.8Ω<br>I <sub>D</sub> ≅5.0A, V <sub>GEN</sub> =4.5V<br>R <sub>G</sub> =6Ω |      | 10  | 15   | ns   |
|                                 | t <sub>r</sub>       |  |      | 12  | 20   |      |
| Turn-Off Time                   | t <sub>d(off)</sub>  |  |      | 25  | 35   |      |
|                                 | t <sub>f</sub>       |  |      | 10  | 15   |      |

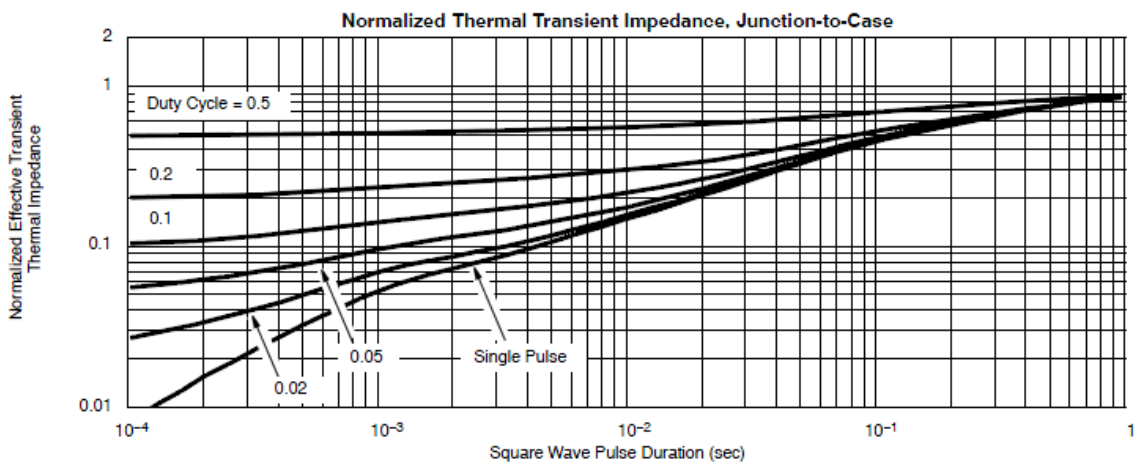
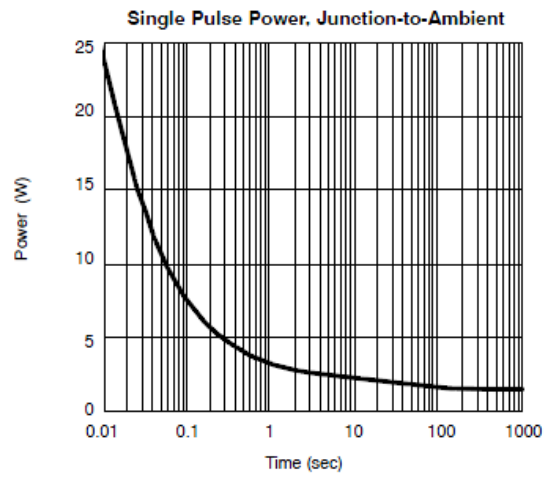
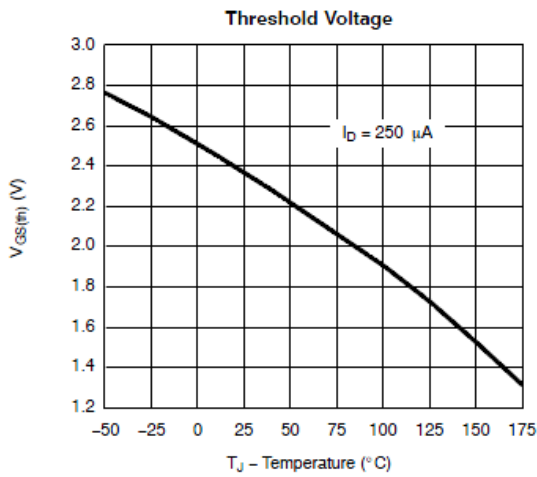
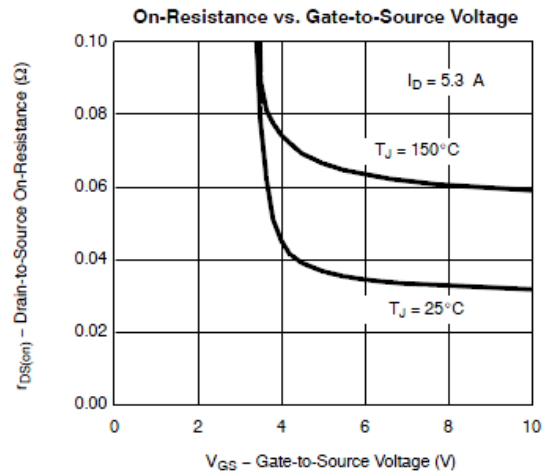
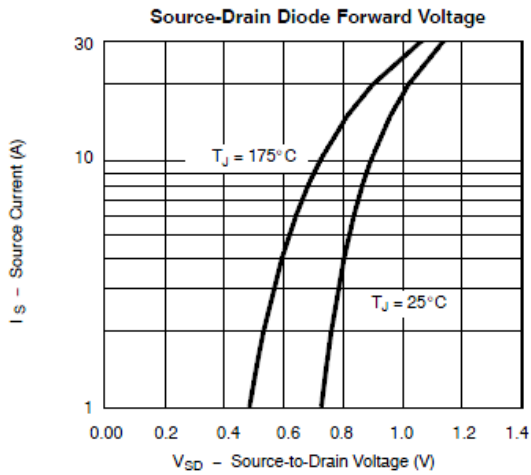


## Typical Characteristics





## Typical Characteristics





**Typical Characteristics**

Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

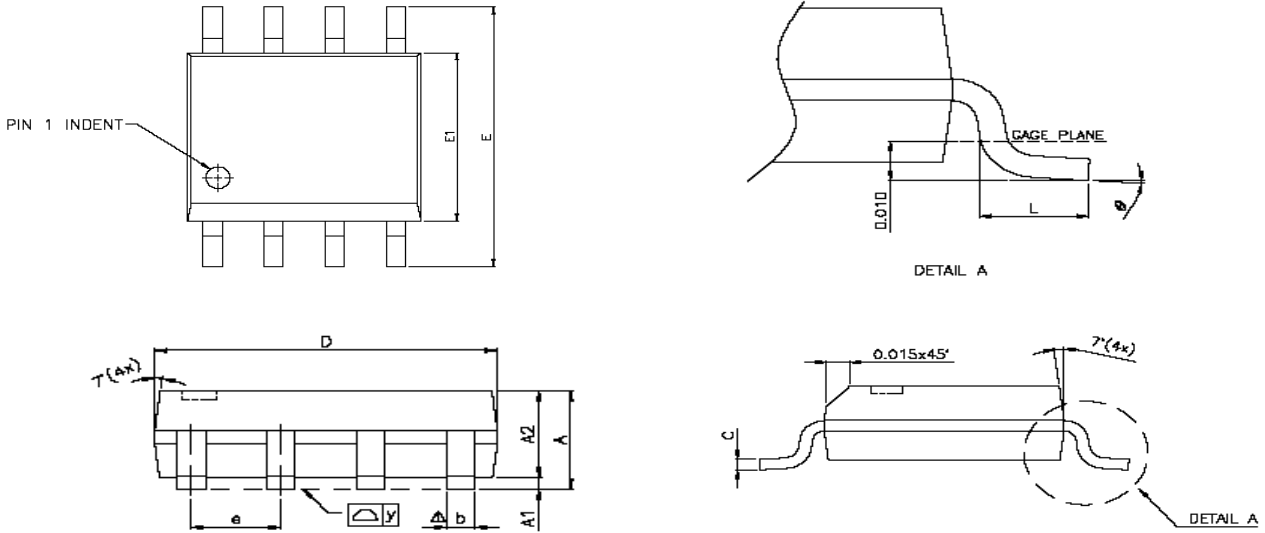


Unclamped Inductive Switching Test Circuit & Waveforms





**Package Information ( SOP-8P )**



| SYMBOLS       | DIMENSIONS IN MILLIMETERS |      |       | DIMENSIONS IN INCHES |       |        |
|---------------|---------------------------|------|-------|----------------------|-------|--------|
|               | MIN                       | NOM  | MAX   | MIN                  | NOM   | MAX    |
| A             | 1.47                      | 1.60 | 1.73  | 0.058                | 0.063 | 0.068  |
| A1            | 0.10                      | —    | 0.25  | 0.004                | —     | 0.010  |
| A2            | —                         | 1.45 | —     | —                    | 0.057 | —      |
| b             | 0.33                      | 0.41 | 0.51  | 0.013                | 0.016 | 0.020  |
| C             | 0.19                      | 0.20 | 0.25  | 0.0075               | 0.008 | 0.0098 |
| D             | 4.80                      | 4.85 | 4.95  | 0.189                | 0.191 | 0.195  |
| E             | 5.80                      | 6.00 | 6.20  | 0.228                | 0.236 | 0.244  |
| E1            | 3.80                      | 3.90 | 4.00  | 0.150                | 0.154 | 0.157  |
| e             | —                         | 1.27 | —     | —                    | 0.050 | —      |
| L             | 0.38                      | 0.71 | 1.27  | 0.015                | 0.028 | 0.050  |
| $\Delta$ y    | —                         | —    | 0.076 | —                    | —     | 0.003  |
| $\varnothing$ | 0°                        | —    | 8°    | 0°                   | —     | 8°     |

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